



TO-3 CASE STYLE

The American Microsemiconductor MJ16018 transistors are designed for high-voltage, high-speed, power switching in inductive circuits where fall time is critical. They are particularly suited for line-operated switchmode applications.

MAXIMUM RATINGS

Rating	Symbol	MJ16018	MJW16018	Unit
Collector–Emitter Voltage	$V_{CEO(sus)}$	800		Vdc
Collector–Emitter Voltage	V_{CEV}	1500		Vdc
Emitter–Base Voltage	V_{EB}	6		Vdc
Collector Current — Continuous — Peak(1)	I_C I_{CM}	10 15		Adc
Base Current — Continuous — Peak(1)	I_B I_{BM}	8 12		Adc
Total Power Dissipation @ $T_C = 25^\circ C$ @ $T_C = 100^\circ C$ Derate above $T_C = 25^\circ C$	P_D	175 100 1	125 50 1	Watts W/ $^\circ C$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	–65 to 200	–55 to 150	$^\circ C$

Storage Time	Baker Clamped ($I_C = 5$ Adc, $I_{B1} = 2$ Adc, $V_{BE(off)} = 2$ Vdc, $V_{CE(pk)} = 400$ Vdc) PW = 25 μs	$(T_J = 25^\circ C)$	t_{sv}	–	4000	8000	ns
Fall Time			t_{fi}	–	60	200	
Crossover Time			t_c	–	90	300	
Storage Time		$(T_J = 100^\circ C)$	t_{sv}	–	4500	9000	
Fall Time			t_{fi}	–	80	250	
Crossover Time			t_c	–	110	375	
Resistive Load (Table 1)							
Delay Time	Baker Clamped ($I_C = 5$ Adc, $V_{CC} = 250$ Vdc, $I_{B1} = 2$ Adc, $I_{B2} = 2$ Adc, $R_{B2} = 3 \Omega$, PW = 25 μs , Duty Cycle $\leq 2\%$)	t_d	–	85	200	ns	
Rise Time		t_r	–	900	2000		
Storage Time		t_s	–	4500	9000		
Fall Time		t_f	–	200	400		

(1) Pulse Test: PW = 300 μs . Duty Cycle $\leq 2\%$.

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS(1)					
Collector–Emitter Sustaining Voltage (Table 1) ($I_C = 50\text{ mA}$, $I_B = 0$)	$V_{CEO(sus)}$	800	–	–	Vdc
Collector Cutoff Current ($V_{CEV} = 1500\text{ Vdc}$, $V_{BE(off)} = 1.5\text{ Vdc}$) ($V_{CEV} = 1500\text{ Vdc}$, $V_{BE(off)} = 1.5\text{ Vdc}$, $T_C = 100^\circ\text{C}$)	I_{CEV}	–	–	0.25 1.5	mAdc
Collector Cutoff Current ($V_{CE} = 1500\text{ Vdc}$, $R_{BE} = 50\ \Omega$, $T_C = 100^\circ\text{C}$)	I_{CER}	–	–	2.5	mAdc
Emitter Cutoff Current ($V_{EB} = 6\text{ Vdc}$, $I_C = 0$)	I_{EBO}	–	–	0.1	mAdc

Collector–Emitter Saturation Voltage ($I_C = 5\text{ Adc}$, $I_B = 2\text{ Adc}$) ($I_C = 10\text{ Adc}$, $I_B = 5\text{ Adc}$) ($I_C = 5\text{ Adc}$, $I_B = 2\text{ Adc}$, $T_C = 100^\circ\text{C}$)	$V_{CE(sat)}$	–	–	1 5 1.5	Vdc
Base–Emitter Saturation Voltage ($I_C = 5\text{ Adc}$, $I_B = 2\text{ Adc}$) ($I_C = 5\text{ Adc}$, $I_B = 2\text{ Adc}$, $T_C = 100^\circ\text{C}$)	$V_{BE(sat)}$	–	–	1.5 1.5	Vdc
DC Current Gain ($I_C = 5\text{ Adc}$, $V_{CE} = 5\text{ Vdc}$)	h_{FE}	4	–	–	–

DYNAMIC CHARACTERISTICS

Output Capacitance ($V_{CB} = 10\text{ Vdc}$, $I_E = 0$, $f_{test} = 1\text{ kHz}$)	C_{ob}	–	–	450	pF
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THERMAL CHARACTERISTICS

Characteristic	Symbol	Max		Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1	1	$^\circ\text{C/W}$
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	T_L	275		$^\circ\text{C}$

(1) Pulse Test: Pulse Width = 5 μs , Duty Cycle $\leq 10\%$.

Delay Time	Baker Clamped ($I_C = 5\text{ Adc}$, $V_{CC} = 250\text{ Vdc}$, $I_{B1} = 2\text{ Adc}$, $I_{B2} = 2\text{ Adc}$, $R_{B2} = 3\ \Omega$, $PW = 25\ \mu\text{s}$, Duty Cycle $\leq 2\%$)	t_d	–	85	200	ns
Rise Time		t_r	–	900	2000	
Storage Time		t_s	–	4500	9000	
Fall Time		t_f	–	200	400	

(1) Pulse Test: $PW = 300\ \mu\text{s}$, Duty Cycle $\leq 2\%$.